

LPM2017 Session Chart (Tentative as of 4-06)

	DAY-1: JUNE 5, 2017 (Mon.)	DAY-2: JUNE 6, 2017 (Tue.)	DAY-3: JUNE 7, 2017 (Wed.)	DAY-4: JUNE 8, 2017 (Thurs.)										
8:30					8:30									
9:00		<table border="1"> <tr> <td>ROOM 1 Room 201-202</td> <td>ROOM 2 Room 203-204</td> <td>ROOM 3 Conference Hall</td> </tr> </table>	ROOM 1 Room 201-202	ROOM 2 Room 203-204	ROOM 3 Conference Hall	<table border="1"> <tr> <td>ROOM 1 Room 201-202</td> <td>ROOM 2 Room 203-204</td> </tr> </table>	ROOM 1 Room 201-202	ROOM 2 Room 203-204	<table border="1"> <tr> <td>ROOM 1 Room 201-202</td> <td>ROOM 2 Room 203-204</td> <td>ROOM 3 Conference Hall</td> </tr> </table>	ROOM 1 Room 201-202	ROOM 2 Room 203-204	ROOM 3 Conference Hall	9:00	
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10:00	<p>Toyama International Conference Center Main Hall (3F)</p> <p>Opening Remark (10:00-10:10)</p> <p>Plenary Session (10:10-12:10)</p>				10:00									
10:30					10:30									
11:00		COFFEE BREAK			11:00									
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12:30	<p>Lunch Time</p>				12:30									
13:00					13:00									
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18:00				18:00										
18:30				18:30										
19:00				19:00										
21:00			<p>To Banquet (on foot from the venue, 18:30-)</p> <p>Banquet (19:00-21:00) ANA Crowne Plaza Toyama (Room "Ohtori" on 3F)</p>	21:00										